

In development
The model is not yet in series production, but will be introduced shortly.

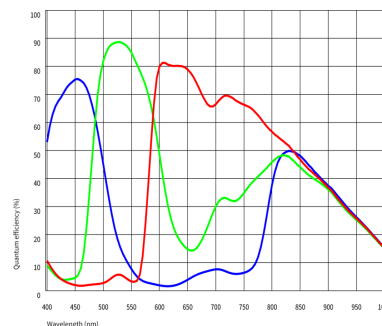


Specification

- PRELIMINARY -

Sensor

Sensor type	CMOS Color
Shutter	Rolling shutter
Sensor characteristic	Linear
Pixel Class	4 MP
Resolution	4.15 Mpix
Resolution (h x v)	2704 x 1536 Pixel
Aspect ratio	16:9
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/1.8"
Optical Size	7.842 mm x 4.454 mm
Optical sensor diagonal	9.02 mm 1/1.8"
Pixel size	2.9 µm
CRA (Chief Ray Angle)	0 °
Manufacturer	Sony
Sensor Model	IMX664-AAQR1-C
Gain (master/RGB)	31.6x/16x
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 2
AOI image height / step width	2 / 2
AOI position grid (horizontal/vertical)	2 / 2
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	Horizontal: mean / Vertical: mean
Binning factor	2x2
Decimation (subsampling) horizontal	-
Decimation (subsampling) vertical	-
Decimation (subsampling) method	M/C automatic
Decimation (subsampling) factor	-



Subject to technical modifications (2026-07-17)

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Model

Frame rate freerun mode	30 fps
Frame rate trigger (maximum)	-
Exposure time (minimum - maximum)	0.04 ms - 1999 ms
Long exposure (maximum)	120034 ms
Power consumption (data interface)	4.2 W
Power consumption (external power supply)	3.9 W
Image memory	128 MB

Ambient conditions

The temperature values given below refer to the outer device temperature of the camera housing.

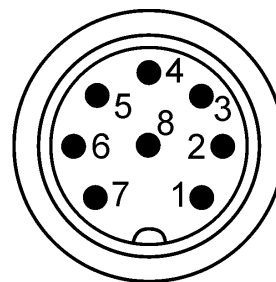
Allowed device temperature during operation	-20 °C - 55 °C / -4 °F - 131 °F
Allowed ambient temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	0 % - 100 %

Connectors

Interface connector	GigE M12, screwable
I/O connector	8-pin Binder connector (Binder series 712: 09-0427-020-08)
Power supply	12 V - 24 V or PoE

Pin assignment I/O connector

1	Trigger input with optocoupler (+) - Line 0
2	Input power supply (VCC) 12-24 V DC
3	General Purpose I/O (GPIO) 1 - Line 2
4	Ground (GND)
5	Flash output with optocoupler (+) - Line 1
6	Flash output with optocoupler (-) - Line 1
7	Trigger input with optocoupler (-) - Line 0
8	General Purpose I/O (GPIO) 2



Design

Lens Mount	C-Mount
IP code	IP66, IP67, IP69, IPx9K
Dimensions H/W/L	41.0 mm x 53.0 mm x 42.7 mm
Mass	175 g
Housing material	Aluminum

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

Image Acquisition

Freerun	✓
Software trigger	-
Hardware trigger	-
Trigger controlled exposure	-
Denoiser	✓
Long exposure	✓
Line scan	-
Global start	-

Flashing

Flashing	✓
PWM flashing	✓

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Image Adjustments	Auto exposure	✓
	Auto gain	✓
	Auto whitebalance	✓
	Color correction	✓
	Gamma	✓
	LUT	✓
	Mirror/flip	X/Y

On-board Image Processing	Pixel formats	
		Mono8 BayerRG8 BayerRG10 BayerRG10p BayerRG12 BayerRG12p BGR8 RGB8 BGR10p32 RGB10p32
	Region of interest	✓
	Decimation (FPGA)	✓
	Decimation (Sensor)	
	Binning (FPGA)	✓
	Binning (Sensor)	2x2 Increases frame rate.

Others	IP settings	✓
	Bandwidth management	✓
	Chunks	✓
	Sequencer	-
	PTP	✓
	Firmware update	✓
	1st supported firmware version	